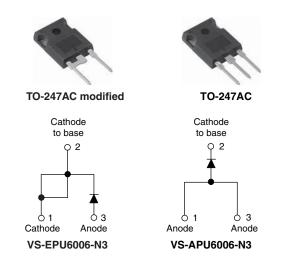
**Vishay Semiconductors** 

# Ultrafast Soft Recovery Diode, 60 A FRED Pt®



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PRODUCT SUMMARY				
Package	TO-247AC modified (2 pins), TO-247AC			
I <sub>F(AV)</sub>	60 A			
V <sub>R</sub>	600 V			
V <sub>F</sub> at I <sub>F</sub>	1.05 V			
t <sub>rr</sub> typ.	32 ns			
T <sub>J</sub> max.	175 °C			
Diode variation	Single die			

#### FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- $\bullet$  Designed and qualified according to JEDEC  $^{\circledast}\text{-}\text{JESD}$  47



COMPLIANT

HALOGEN

FREE

#### **DESCRIPTION / APPLICATIONS**

VS-EPU60/VS-APU60... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, welding, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS					
Repetitive peak reverse voltage	V <sub>RRM</sub>		600	V					
Average rectified forward current in DC	I <sub>F(AV)</sub>	T <sub>C</sub> = 116 °C	60	٨					
Single pulse forward current	I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	600	A					
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C					

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-				
	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	1.2	1.5	V			
Forward voltage		I <sub>F</sub> = 60 A, T <sub>J</sub> = 125 °C	-	1.1	1.3				
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 175 °C	-	1.05	1.2				
Reverse leakage current	I <sub>R</sub>	$V_{R} = V_{R}$ rated	-	-	30				
		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	200	μA			
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	38	-	pF			

Revision: 10-Jul-15

Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS			
		$I_F = 1 \text{ A}, \ dI_F/dt = 20$	00 A/µs, V <sub>R</sub> = 30 V	-	32	43			
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	110	-	ns		
		T <sub>J</sub> = 125 °C		-	200	-			
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 60 A dI <sub>F</sub> /dt = 200 A/μs	-	10	-	А		
Feak recovery current		T <sub>J</sub> = 125 °C	$V_{\rm R} = 200 \text{ V}$	-	19	-	A		
D	0	T <sub>J</sub> = 25 °C		-	530	-			
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1900	-	nC		

THERMAL - MECHAN	THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C				
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	0.65					
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	70	°C/W				
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.5	-					
Maight			-	6	-	g				
Weight			-	0.21	-	oz.				
Mounting torque			6 (5)	-	1.2 (10)	kgf. cm (lbf ⋅ in)				
Marking davias		Case style TO-247AC modified	EPU6006							
Marking device		Case style TO-247AC		APU6006						



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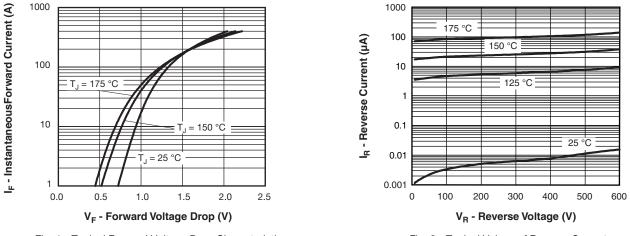


Fig. 1 - Typical Forward Voltage Drop Characteristics

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

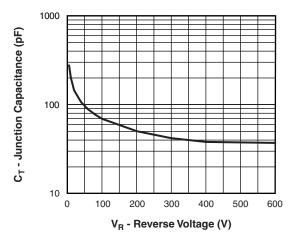
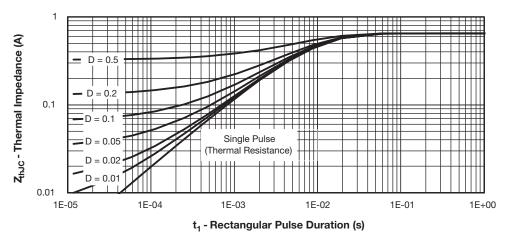


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

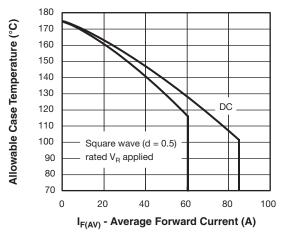




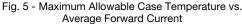
 Revision: 10-Jul-15
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 Document Number: 94794

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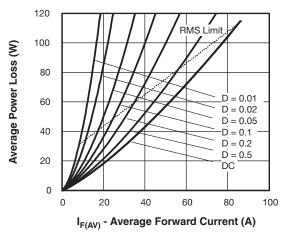


Fig. 6 - Forward Power Loss Characteristics

#### Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;  $\begin{array}{l} \mathsf{Pd} = \mathsf{Forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \times \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see fig. 6}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{Inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \times \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{80} \ \% \ \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$ 

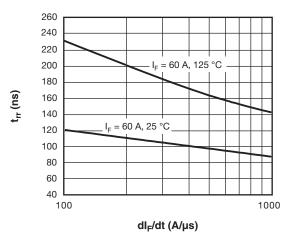


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

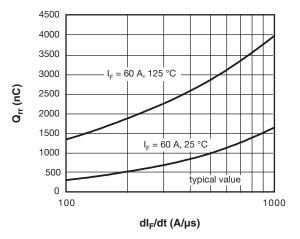


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt



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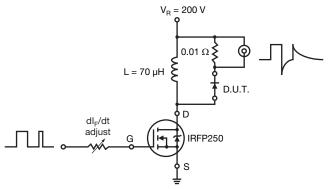


Fig. 9 - Reverse Recovery Parameter Test Circuit

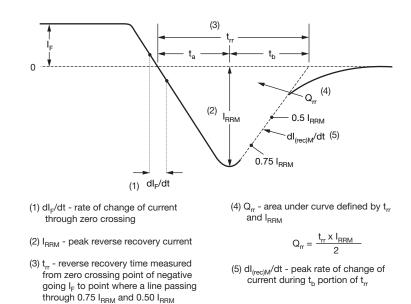


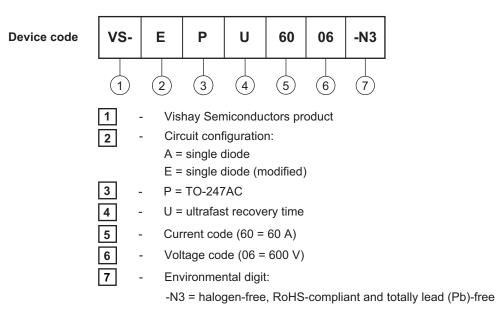
Fig. 10 - Reverse Recovery Waveform and Definitions

extrapolated to zero current.



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#### **ORDERING INFORMATION TABLE**



ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-EPU6006-N3	25	500	Antistatic plastic tube					
VS-APU6006-N3	25	500	Antistatic plastic tube					

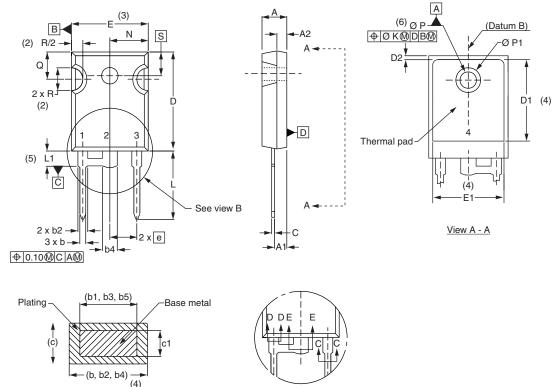
LINKS TO RELATED DOCUMENTS							
Dimensions	TO-247AC modified	www.vishay.com/doc?95541					
	TO-247AC	www.vishay.com/doc?95542					
Part marking information	TO-247AC modified	www.vishay.com/doc?95442					
	TO-247AC	www.vishay.com/doc?95007					





TO-247 - 50 mils L/F modified

#### **DIMENSIONS** in millimeters and inches



Section C - C, D - D, E - E



View	В

SYMBOL	MILLIN	IETERS	INC	NOTES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	MILLIMETERS		INCHES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
D2	0.51	1.35	0.020	0.053		
E	15.29	15.87	0.602	0.625	3	
E1	13.46	-	0.53	-		
е	5.46	BSC	0.215	BSC		
ØК	0.254		0.0	)10		
L	14.20	16.10	0.559	0.634		
L1	3.71	4.29	0.146	0.169		
N	7.62	BSC	0.3			
ØΡ	3.56	3.66	0.14	0.144		
Ø P1	-	7.39	-	0.291		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51	BSC	0.217	BSC		

#### Notes

- <sup>(1)</sup> Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q

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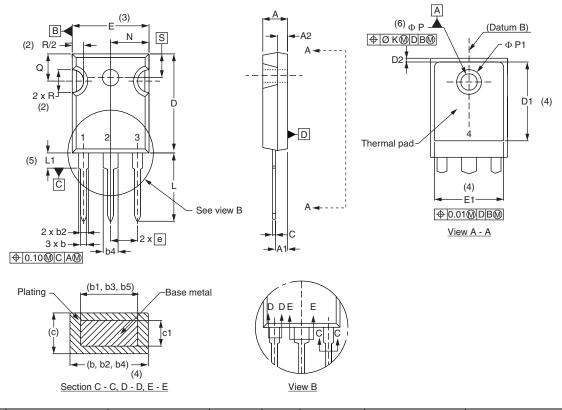
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TO-247 - 50 mils L/F

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	NOTES SYMBO		MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			Е	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			ØК	0.2	254	0.0	)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ØР	3.56	3.66	0.14	0.144	
с	0.38	0.89	0.015	0.035			Ø P1	-	7.39	-	0.291	
c1	0.38	0.84	0.015	0.033			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3		R	4.52	5.49	0.178	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

#### Notes

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